

LT3572

Dual Full-Bridge Piezo Driver with 900mA Boost Converter

FEATURES

- 2.7V to 10V Input Voltage Range
- 900mA Boost Converter
- Dual Full-Bridge Piezo Drivers
- Up to 100kHz PWM Frequency
- Programmable Switching Frequency from 500kHz to 2.25MHz
- Synchronizable Up to 2.5MHz
- Soft-Start
- Separate Enable for Each Piezo Driver and Boost Converter
- Available in a 4mm × 4mm 20-Pin QFN Package

APPLICATIONS

Piezo Motor Drive

DESCRIPTION

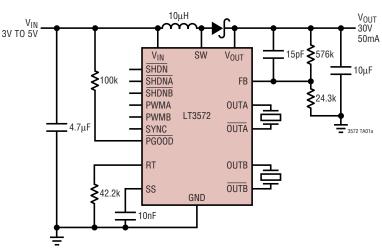
The LT[®]3572 is a highly integrated dual Piezo motor driver capable of driving two Piezo motors at up to 40V with a PWM frequency up to 100kHz from a 5V supply. Each Piezo driver can be independently turned on or off along with the boost converter.

The boost regulator has a soft-start capability that limits the inrush current at start-up. The boost regulator switching frequency is set by an external resistor or the frequency can be synchronized by an external clock. A \overrightarrow{PGOOD} pin indicates when the output of the boost converter is in regulation and the Piezo drivers are allowed to start switching.

The LT3572 is available in a (4mm \times 4mm) 20-pin QFN package.

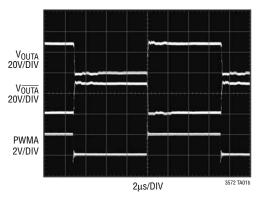
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TYPICAL APPLICATION



Dual Piezo Driver

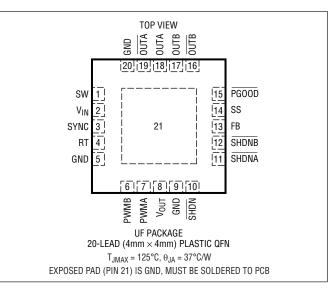
Response Driving Piezo Motor at 70kHz



ABSOLUTE MAXIMUM RATINGS (Note 1)

(NOLE I)	
V _{OUT} Voltage	40V
OUTA, OUTA, OUTB, OUTB Voltage	40V
SW Voltage	42V
RT, SS, SYNC	2V
All Other Pins	
Maximum Junction Temperature	125°C
Operating Temperature Range (Note 2)	40°C to 85°C
Storage Temperature Range	–65°C to 125°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT3572EUF#PBF	LT3572EUF#TRPBF	3572	20-Lead (4mm × 4mm) Plastic DFN	–40°C to 85°C

Consult LTC Marketing for parts specified with wider operating temperature ranges.

Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{IN} = 5V, V_{SHDNA} = V_{SHDNB} = V_{SHDN} = 5V, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Minimum Operating Voltage		•		2.5	2.7	V
V _{IN} Quiescent Current	V _{FB} = 1.3V			3.4	4	mA
V _{IN} Shutdown Current	$V_{\overline{SHDNA}} = V_{\overline{SHDNB}} = 0V$			0	1	μA
SHDN Pin Threshold			0.3		1.5	V
SHDNA Pin Threshold			0.3		1.5	V
SHDNB Pin Threshold			0.3		1.5	V
SHDN Pin Bias Current	$V_{\overline{SHDN}} = 5V, V_{\overline{SHDNA}} = 0V, V_{\overline{SHDNB}} = 0V$ $V_{\overline{SHDN}} = 0V, V_{\overline{SHDNA}} = 0V, V_{\overline{SHDNB}} = 0V$			8 0.1	15 1	μA μA
SHDNA Pin Bias Current	$V_{SHDN} = 0V, V_{SHDNA} = 5V, V_{SHDNB} = 0V$ $V_{SHDN} = 0V, V_{SHDNA} = 0V, V_{SHDNB} = 0V$			8 0.1	15 1	μA μA
SHDNB Pin Bias Current	$V_{\overline{SHDN}} = 0V, V_{\overline{SHDNA}} = 0V, V_{\overline{SHDNB}} = 5V$ $V_{\overline{SHDN}} = 0V, V_{\overline{SHDNA}} = 0V, V_{\overline{SHDNB}} = 0V$			8 0.1	15 1	μA μA



3572f

2

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{IN} = 5V, V_{SHDNA} = V_{SHDNB} = V_{SHDN} = 5V, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
PWMA Pin Threshold			0.3		1.5	V
PWMB Pin Threshold			0.3		1.5	V
PGOOD Rising Threshold	(Note 3)	•	1.12	1.16	1.19	V
PGOOD Falling Threshold	(Note 4)	•	1.01	1.04	1.065	V
PGOOD Resistance		•		1	3	kΩ
Switching Frequency	RT = 75.0kΩ RT = 13.0kΩ	•	425 1.9	500 2.25	575 2.6	kHz MHz
Maximum Duty Cycle	RT = 75.0kΩ RT = 13.0kΩ	•	95 85			% %
Synchronization Frequency			575		2500	kHz
SYNC Pin Thresholds	(Note 5)		0.3		1.5	V
SS Current				4.5		μA
FB Pin Voltage		•	1.195	1.225	1.255	V
FB Pin Voltage Line Regulation	V _{IN} = 2.5V to 10V			0.01	0.05	%/V
FB Pin Bias Current	V _{FB} = 1.225V (Note 6)			50	200	nA
SW Current Limit	(Note 7)		0.9	1.3	1.7	A
SW V _{CESAT}	I _{SW} = 800mA			310	450	mV
SW Leakage Current	SW = 40V			0.2	5	μA
OUTx Rise Time	C = 2.2nF, V _{OUT} = 30V				100	ns
OUTx Fall Time	C = 2.2nF, V _{OUT} = 30V				100	ns

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LT3572 is guaranteed to meet specified performance from 0°C to 70°C operating junction temperature. Specifications over the -40°C to 85°C operating junction temperature range are assured by design, characterization and correlation with statistical process controls.

Note 3: Rising threshold voltage on FB pin that pulls PGOOD low.

Note 4: Falling threshold voltage on FB pin that causes a high impedance on PGOOD.

Note 5: Minimum pulse width is 100ns. Maximum off pulse width is 100ns.

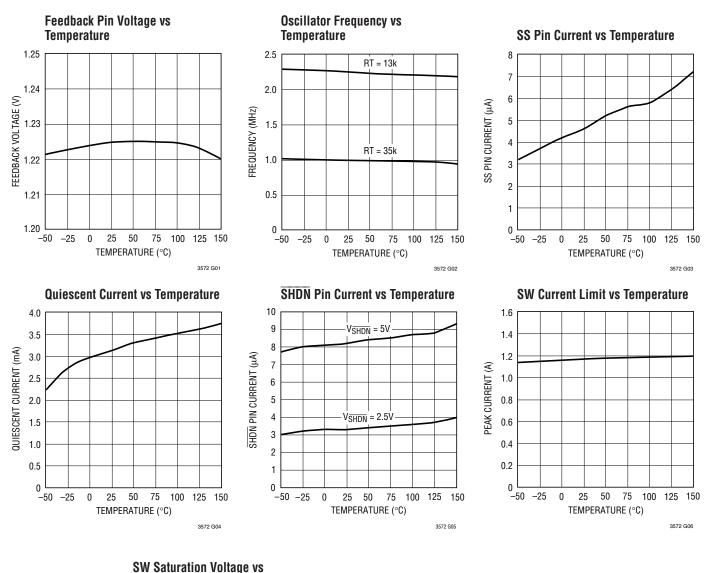
Note 6: Current flows into the pin.

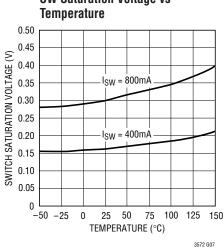
Note 7: Current limit guaranteed by design and/or correlation to static test. Note 8: OUTx refers to OUTA, OUTA, OUTB, OUTB.



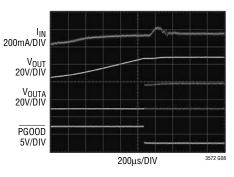
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TYPICAL PERFORMANCE CHARACTERISTICS





Start-Up





PIN FUNCTIONS

SW (Pin 1): Switch Node. This pin connects to the collector of an internal NPN power switch.

 V_{IN} (Pin 2): Input Supply Pin. This pin must be locally bypassed with a capacitor.

SYNC (Pin 3): Synchronization Pin. This pin is used to synchronize the internal oscillator to an external signal. The synchronizing range is 15% above the free running frequency set by the RT pin up to 2.5MHz. If not used, this pin must be tied to GND.

RT (Pin 4): Frequency Set Pin. Place a resistor to GND to set the internal frequency. The range of oscillation is 500kHz to 2.25MHz.

GND (Pins 5, 9, 20): Ground.

PWMB (Pin 6): Logic Input for the Driver. A high signal on this input sets OUTB high and OUTB low.

PWMA (Pin 7): Logic Input for the Driver. A high signal on this input sets OUTA high and OUTA low.

V_{OUT} (Pin 8): Output for the Switching Regulator and the Input Supply for the Drivers.

SHDN (Pin 10): Shutdown Pin. Tie to 1.5V or more to enable the switcher. Pull low to disable the switcher.

SHDNA (Pin 11): Shutdown Pin. Tie to 1.5V or more to enable OUTA and OUTA. Pull low to place OUTA and OUTA in a high impedance state.

SHDNB (Pin 12): Shutdown Pin. Tie to 1.5V or more to enable OUTB and OUTB. Pull low to place OUTB and OUTB in a high impedance state.

FB (Pin 13): Feedback Pin. The LT3572 regulates this pin to 1.225V. Connect the feedback resistors to this pin to set the output voltage for the switching regulator.

SS (Pin 14): Soft-Start Pin. Place a soft-start capacitor here. A capacitor on the soft-start pin slowly ramps the current limit of the part from OA to 1.3A.

PGOOD (Pin 15): This pin is an open-drain output that pulls low when the FB pin is within 95% of its regulation value.

OUTB (Pin 16): The Output Driver. This node switches between V_{OUT} and GND and is inverted from OUTB.

OUTB (Pin 17): The Output Driver. This node switches between V_{OUT} and GND.

OUTA (Pin 18): The Output Driver. This node switches between V_{OUT} and GND .

OUTA (Pin 19): The Output Driver. This node switches between V_{OUT} and GND and is inverted from OUTA.

Exposed Pad (Pin 21): Ground. The Exposed Pad of the package provides both electrical contact to ground and good thermal contact to the printed circuit board. The Exposed Pad must be soldered to the circuit board for proper operation.

BLOCK DIAGRAM

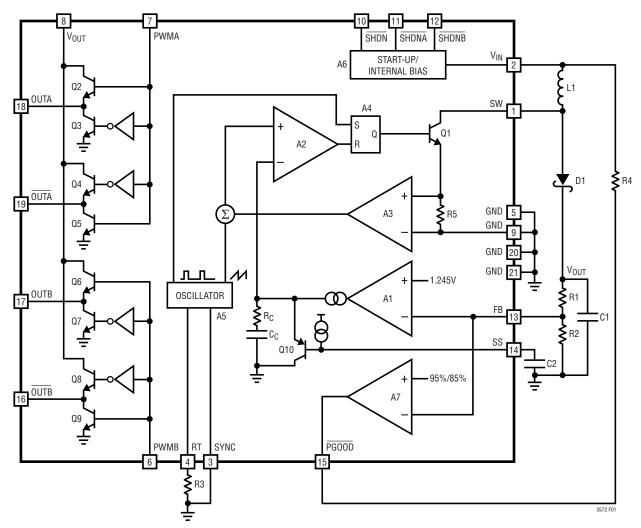


Figure 1. Block Diagram



OPERATION

Switching Regulator

The LT3572 uses a constant frequency, current mode, control scheme to provide excellent line and load regulation for the output drivers. Operation can be best understood by referring to the Block Diagram in Figure 1. A pulse from the oscillator sets the RS flip-flop, A4, and turns on the internal NPN bipolar power switch, Q1. Current in Q1 and the external inductor, L1, begins to increase. When this current exceeds a level determined by the voltage at the output of the error amplifier A1, comparator A2 resets A4, turning Q1 off. The current in L1 flows through the external Schottky diode D1 and begins to decrease. The cycle begins again at the next pulse from the oscillator. In this way, the voltage at the output of the error amplifier controls the current through the indictor to the output. The soft-start capacitor, C2, clamps the output of the error

amplifier causing the current limit to slowly increase. This helps reduce overshoot on the output and helps minimize inrush current on the input.

Output Drivers

The function of the driver section is to level shift the input of the PWM pins to the voltage of the V_{OUT} pin. The drivers operate in an H-bridge fashion, where the OUTA and OUTB pins are the same polarity as the PWMA and PWMB pins respectively and the OUTA and OUTB are inverted from PWMA and PWMB respectively. The OUT pins will be high impedance until the FB pin is within 95% of its regulated voltage. The OUT pins will follow PWMA and PWMB as long as FB stays within 85% of the regulated voltage. If FB drops below 85%, the OUT pins will go high impedance.

APPLICATIONS INFORMATION

Duty Cycle

The typical maximum duty cycle of the LT3572 is 95% at 1MHz. This maximum duty cycle reduces as the switching frequency is increased. The duty cycle for a given application is given by:

$$DC = \frac{V_{OUT} + V_D - V_{IN}}{V_{OUT} + V_D - V_{CESAT}}$$

where V_D is the diode forward drop, typically 0.5V and V_{CESAT} is, in the worst case, 310mV at 0.8A. The LT3572 can be used at higher duty cycles, but must be operated in the discontinuous mode so that the actual duty cycle is reduced.

FB Resistor Network

The output voltage is programmed with a resistor divider between the output and the FB pin. Choose the resistors according to:

$$R1 = R2\left(\frac{V_{OUT}}{1.225V} - 1\right)$$

Shutdown Pins

When held below 0.3V, SHDNA and SHDNB prevent the drivers from switching and keep the outputs in a high impedance state. If SHDN is held below 0.3V then the switching regulator is prevented from turning on. When any one of these pins are pulled above 1.5V the internal circuitry is turned on and the respective output is allowed to operate. When the LT3572 is not in use all three pins should be pulled low.

Oscillator

The LT3572 can operate at switching frequencies from 500kHz up to 2.25MHz by changing the value of the resistor R3 on the RT pin. Figure 2 shows a graph of RT vs Switching Frequency.

The oscillator can be synchronized with an external clock applied to the SYNC pin. When synchronizing the oscillator, the free running frequency must be set approximately

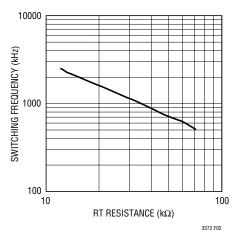


Figure 2. RT Resistance vs Switching Frequency

15% lower than the desired synchronized frequency. If the sync function is not used the SYNC pin must be tied to ground.

PGOOD

The part has a power good feature that detects when the output boost converter is up and in regulation. When the part is turned off or not in regulation the PGOOD pin is in a high impedance state. When the part is within 95% of regulation the PGOOD pin is pulled low signaling that the output is valid. If the output then falls below 85% of regulation the PGOOD pin is put back in a high impedance state. Whenever the output is not in regulation the output pins in the driver aren't allowed to switch and are placed in a high impedance state. The PGOOD pin is an open drain of an NMOS devices with an impedance of 1k Ω and should be tied to V_{IN} through a resistor.

Soft-Start

The soft-start feature limits the inrush current drawn from the supply upon start-up. An internal current source with a nominal 4.5μ A current source charges an external capacitor C2. The voltage on the soft-start pin is used to control the output of the error amplifier, which limits the maximum peak current through the inductor and the inrush current drawn from the supply during start-up.



APPLICATIONS INFORMATION

Inductor Selection

A 10µH inductor is recommended for most LT3572 applications. Choose an inductor that will handle at least 1A without saturating, and ensure that the inductor has a low DCR (copper-wire resistance) to minimize I²R power losses. Table 1 lists several inductor manufacturers.

Sumida	(847) 956-0666	www.sumida.com	
TDK	(847) 803-6100	www.tdk.com	
Murata	(714) 852-2001	www.murata.com	
FDK	(408) 432-8331	www.tdk.co.jp	

Table 1. Inductor Manufacturers

Capacitor Selection

The small size of ceramic capacitors makes them ideal for LT3572 applications. Only X5R or X7R types should be used because they retain their capacitance over wider voltage and temperature ranges than other types such as Y5V or Z5U. A 4.7μ F to 15μ F output capacitor is sufficient for stable transient response, however, more output capacitance can help limit the voltage droop on V_{OUT} during transients.

Ceramic capacitors also make a good choice for the input decoupling capacitor, which should be placed as close as possible to the LT3572. A 1μ F to 4.7μ F input capacitor

is sufficient for most applications. Table 2 shows a list of several ceramic capacitor manufacturers. Consult the manufacturers for detailed information on their entire selection of ceramic parts.

Table 2. Ceramic Capacitor Manufacturers	ic Capacitor Manufacturers	Capacitor	Ceramic	Table 2.
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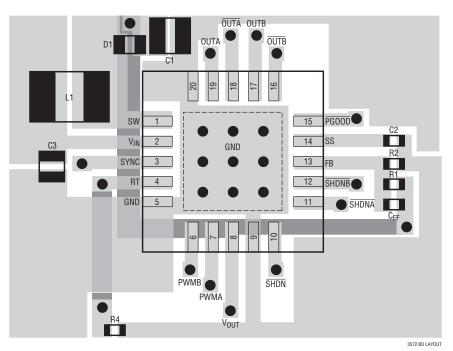
		•
Taiyo Yuden	(408) 573-4150	www.t-yuden.com
AVX	(803) 448-9411	www.avxcorp.com
Murata	(714) 852-2001	www.murata.com

Diode Selection

A Schottky diode is recommended for use with the LT3572. The Philips PMEG 3005 is a good choice. If the switch voltage exceeds 30V, a PMEG 4005 (a 40V diode) can be used. These diodes are rated to handle an average forward current of 0.5A. For higher efficiency, use a diode with better thermal characteristics such as the On Semiconductor MBRM140 (a 40V diode).

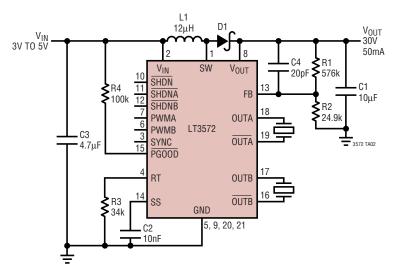
Layout Hints

As with all switching regulators, careful attention must be paid to the PCB board layout and component placement. To maximize efficiency, switch rise and fall times are made as short as possible. Note the vias under the Exposed Pad. These should connect to a local ground plane for better thermal performance.



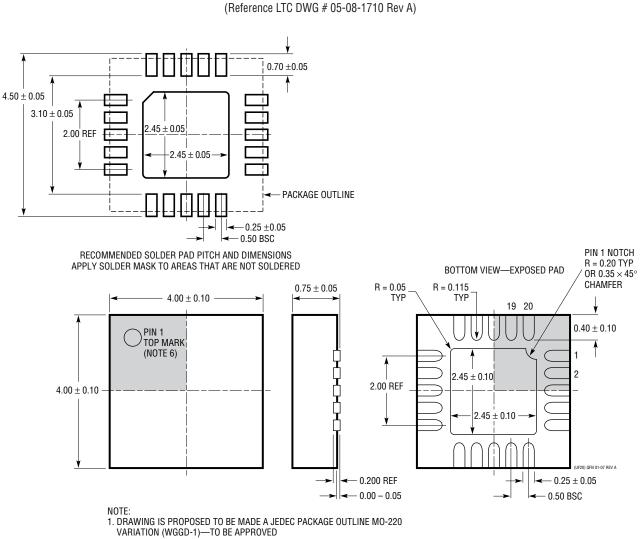
TECHNOLOGY

TYPICAL APPLICATION



3572f

PACKAGE DESCRIPTION



UF Package 20-Lead Plastic QFN (4mm × 4mm)

- 2. DRAWING NOT TO SCALE
- 3. ALL DIMENSIONS ARE IN MILLIMETERS
- 4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE
- MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
- EXPOSED FAD SHALL BE SOLDER PLATED
 SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1160	Half-/Full-Bridge N-Channel MOSFET Driver	V _{IN} : 10V to 15V, V _{OUT(MAX)} = 60V, 24-Lead SO Package
LT3469	Piezo Microactuator Driver with Boost Regulator	V_{IN} : 2.5V to 16V, V_{OUT} = 35V Maximum, 40mA Current Limit for Piezo Microactuator
LT3479	3A, Full Featured DC/DC Converter with Soft-Start and Inrush Current Protection	V_{IN} : 2.5V to 24V, $V_{OUT(MAX)}$ = 40V, I_Q = Analog/PWM, I_{SD} < 1 μ A, DFN, TSSOP Packages
LT3580	42V, 2A, 2.5MHz High Efficiency Step-Up DC/DC Converter	V_{IN} : 2.5V to 32V, $V_{OUT(MAX)}$ = 40V, I_Q = 1mA, I_{SD} < 1µA, 3mm \times 3mm DFN8 and MS8E Packages

